Input Voltage = 12Vin to 50Vin

*NOTES:

1. Design is built on the PMP7896 RevB PCB.

54Vout @ 2.5A

*NOTES:

1. Design is built on the PMP7896 RevB PCB.
These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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